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Understanding Embedded - FPGAs (Field Programmable Gate Array)

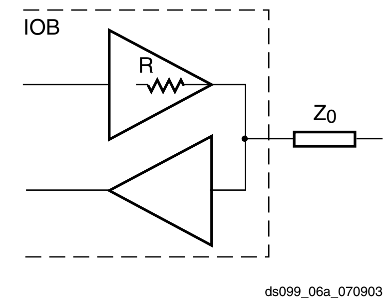
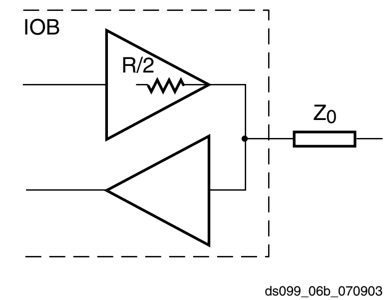
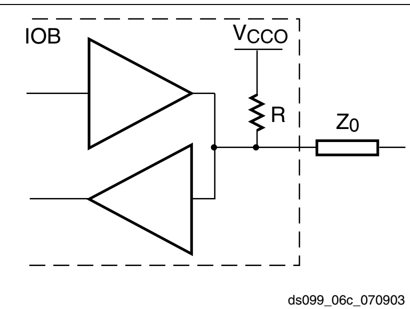
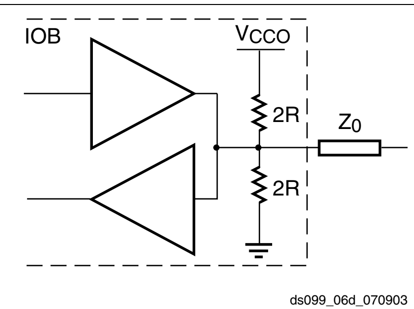
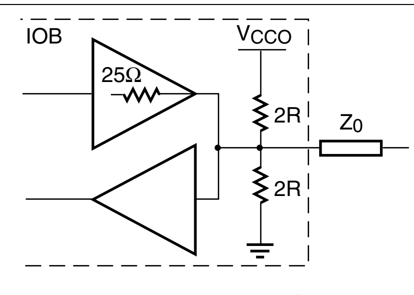
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	192
Number of Logic Elements/Cells	1728
Total RAM Bits	73728
Number of I/O	97
Number of Gates	50000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s50-4tq144i

Table 11: **DCI Terminations**

Termination	Schematic[1]	Signal Standards (IOSTANDARD)
Controlled impedance output driver		LVDCI_15 LVDCI_18 LVDCI_25 LVDCI_33 HSLVDCI_15 HSLVDCI_18 HSLVDCI_25 HSLVDCI_33
Controlled output driver with half impedance		LVDCI_DV2_15 LVDCI_DV2_18 LVDCI_DV2_25 LVDCI_DV2_33
Single resistor		GTL_DCI GTLP_DCI HSTL_III_DCI[2] HSTL_III_DCI_18[2]
Split resistors		HSTL_I_DCI[2] HSTL_I_DCI_18[2] HSTL_II_DCI_18 DIFF_HSTL_II_18_DCI DIFF_SSTL2_II_DCI LVDS_25_DCI LVDSEXT_25_DCI
Split resistors with output driver impedance fixed to 25Ω		SSTL18_I_DCI[3] SSTL2_I_DCI[3] SSTL2_II_DCI

Notes:

1. The value of R is equivalent to the characteristic impedance of the line connected to the I/O. It is also equal to half the value of RREF for the DV2 standards and RREF for all other DCI standards.
2. For DCI using HSTL Classes I and III, terminations only go into effect at inputs (not at outputs).
3. For DCI using SSTL Class I, the split termination only goes into effect at inputs (not at outputs).

The DLL component has two clock inputs, CLKIN and CLKFB, as well as seven clock outputs, CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV as described in Table 16. The clock outputs drive simultaneously; however, the High Frequency mode only supports a subset of the outputs available in the Low Frequency mode. See DLL Frequency Modes, page 35. Signals that initialize and report the state of the DLL are discussed in The Status Logic Component, page 41.

Table 16: **DLL Signals**

Signal	Direction	Description	Mode Support	
			Low Frequency	High Frequency
CLKIN	Input	Accepts original clock signal.	Yes	Yes
CLKFB	Input	Accepts either CLK0 or CLK2X as feed back signal. (Set CLK_FEEDBACK attribute accordingly).	Yes	Yes
CLK0	Output	Generates clock signal with same frequency and phase as CLKIN.	Yes	Yes
CLK90	Output	Generates clock signal with same frequency as CLKIN, only phase-shifted 90°.	Yes	No
CLK180	Output	Generates clock signal with same frequency as CLKIN, only phase-shifted 180°.	Yes	Yes
CLK270	Output	Generates clock signal with same frequency as CLKIN, only phase-shifted 270°.	Yes	No
CLK2X	Output	Generates clock signal with same phase as CLKIN, only twice the frequency.	Yes	No
CLK2X180	Output	Generates clock signal with twice the frequency of CLKIN, phase-shifted 180° with respect to CLKIN.	Yes	No
CLKDV	Output	Divides the CLKIN frequency by CLKDV_DIVIDE value to generate lower frequency clock signal that is phase-aligned to CLKIN.	Yes	Yes

The clock signal supplied to the CLKIN input serves as a reference waveform, with which the DLL seeks to align the feedback signal at the CLKFB input. When eliminating clock skew, the common approach to using the DLL is as follows: The CLK0 signal is passed through the clock distribution network to all the registers it synchronizes. These registers are either internal or external to the FPGA. After passing through the clock distribution network, the clock signal returns to the DLL via a feedback line called CLKFB. The control block inside the DLL measures the phase error between CLKFB and CLKIN. This phase error is a measure of the clock skew that the clock distribution network introduces. The control block activates the appropriate number of delay elements to cancel out the clock skew. Once the DLL has brought the CLK0 signal in phase with the CLKIN signal, it asserts the LOCKED output, indicating a “lock” on to the CLKIN signal.

DLL Attributes and Related Functions

A number of different functional options can be set for the DLL component through the use of the attributes described in Table 17. Each attribute is described in detail in the sections that follow:

Table 17: **DLL Attributes**

Attribute	Description	Values
CLK_FEEDBACK	Chooses either the CLK0 or CLK2X output to drive the CLKFB input	NONE, 1X, 2X
DLL_FREQUENCY_MODE	Chooses between High Frequency and Low Frequency modes	LOW, HIGH
CLKIN_DIVIDE_BY_2	Halves the frequency of the CLKIN signal just as it enters the DCM	TRUE, FALSE
CLKDV_DIVIDE	Selects constant used to divide the CLKIN input frequency to generate the CLKDV output frequency	1.5, 2, 2.5, 3, 3.5, 4, 4.5, 5, 5.5, 6.0, 6.5, 7.0, 7.5, 8, 9, 10, 11, 12, 13, 14, 15, and 16.
DUTY_CYCLE_CORRECTION	Enables 50% duty cycle correction for the CLK0, CLK90, CLK180, and CLK270 outputs	TRUE, FALSE

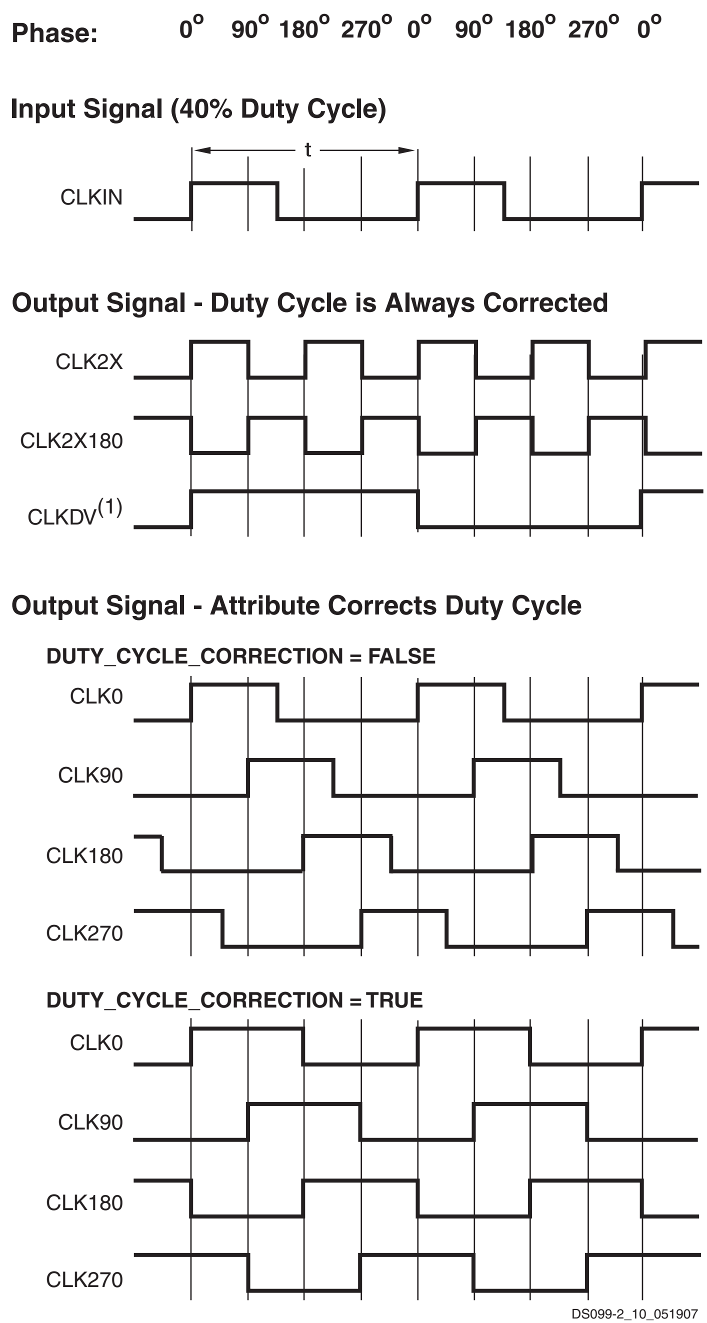


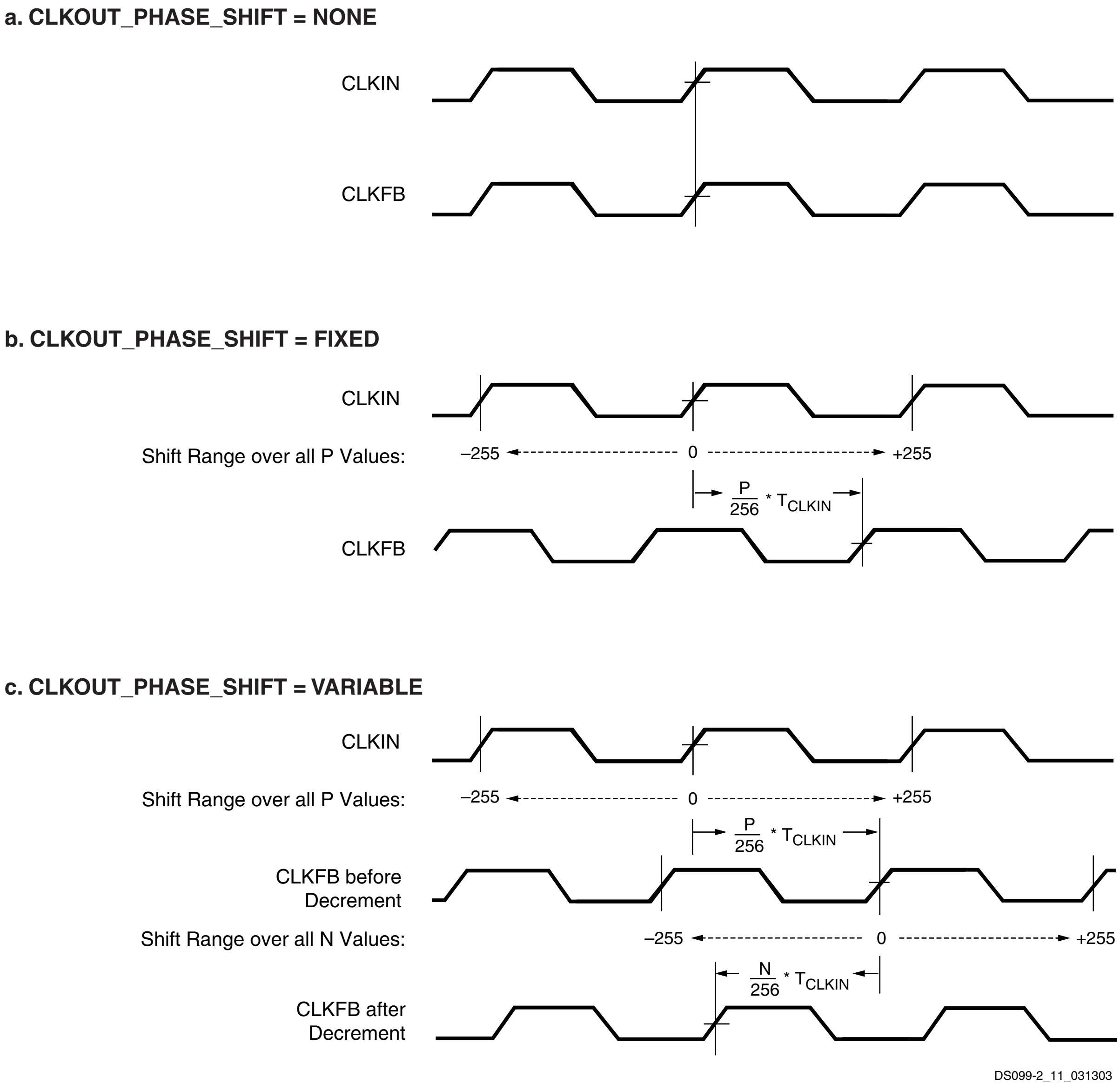
Figure 22: **Characteristics of the DLL Clock Outputs**

Digital Frequency Synthesizer (DFS)

The DFS component generates clock signals the frequency of which is a product of the clock frequency at the CLKIN input and a ratio of two user-determined integers. Because of the wide range of possible output frequencies such a ratio permits, the DFS feature provides still further flexibility than the DLL's basic synthesis options as described in the preceding section. The DFS component's two dedicated outputs, CLKFX and CLKFX180, are defined in Table 19.

The signal at the CLKFX180 output is essentially an inversion of the CLKFX signal. These two outputs always exhibit a 50% duty cycle. This is true even when the CLKIN signal does not. These DFS clock outputs are driven at the same time as the DLL's seven clock outputs.

The numerator of the ratio is the integer value assigned to the attribute CLKFX_MULTIPLY and the denominator is the integer value assigned to the attribute CLKFX_DIVIDE. These attributes are described in Table 18.



Notes:

1. P represents the integer value ranging from –255 to +255 to which the PHASE_SHIFT attribute is assigned.
2. N is an integer value ranging from –255 to +255 that represents the net phase shift effect from a series of increment and/or decrement operations.
   N = {Total number of increments} – {Total number of decrements}
   A positive value for N indicates a net increment; a negative value indicates a net decrement.

Figure 23: **Phase Shifter Waveforms**

The Status Logic Component

The Status Logic component not only reports on the state of the DCM but also provides a means of resetting the DCM to an initial known state. The signals associated with the Status Logic component are described in Table 22.

As a rule, the Reset (RST) input is asserted only upon configuring the device or changing the CLKIN frequency. A DCM reset does not affect attribute values (e.g., CLKFX_MULTIPLY and CLKFX_DIVIDE). If not used, RST must be tied to GND.

The eight bits of the STATUS bus are defined in Table 23.

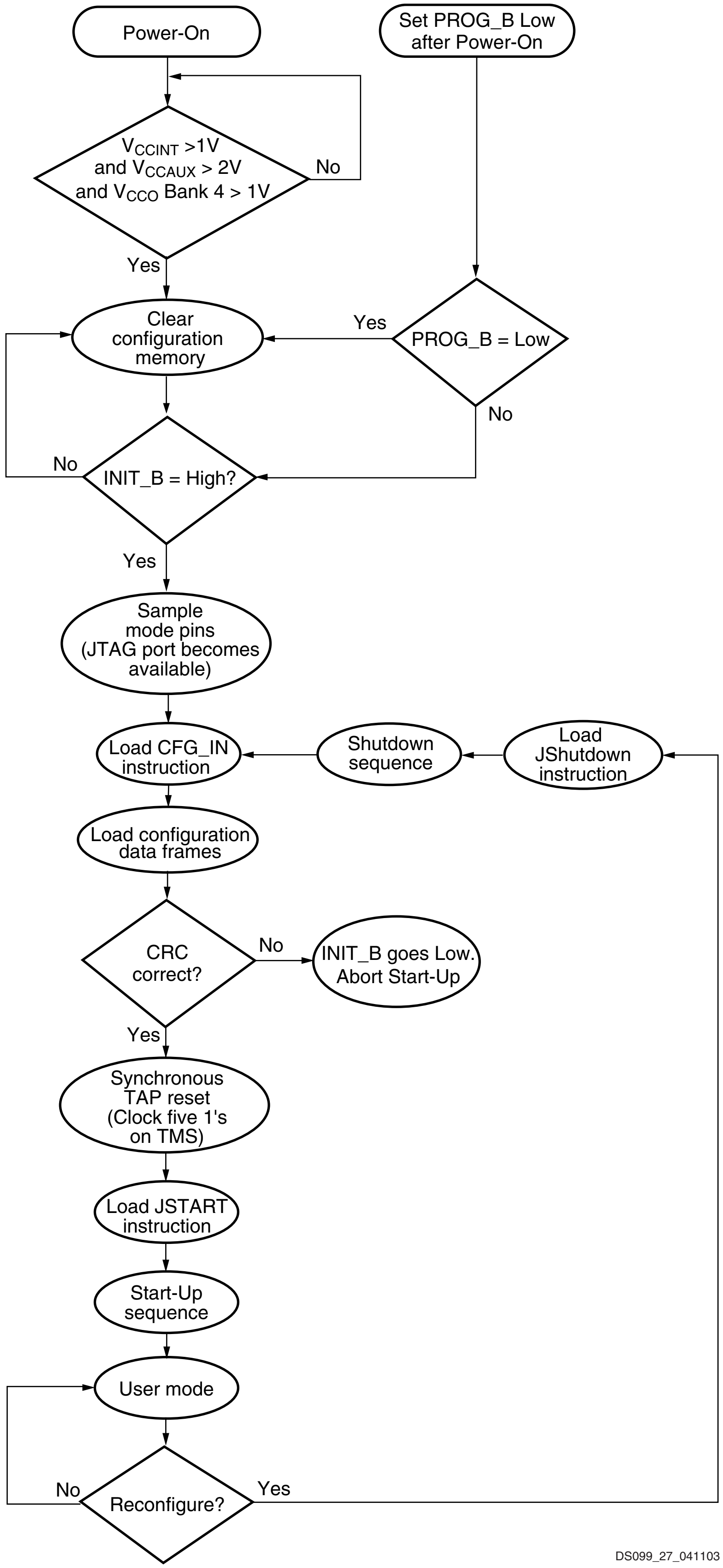


Figure 30: **Boundary-Scan Configuration Flow Diagram**

Table 28: **Absolute Maximum Ratings *(Cont'd)***

Symbol	Description	Conditions	Min	Max	Units
I_{IK}	Input clamp current per I/O pin	$-0.5\text{ V} < V_{IN} < (V_{CCO} + 0.5\text{ V})$	–	±100	mA
V_{ESD}	Electrostatic Discharge Voltage pins relative to GND	Human body model	–	±2000	V
		Charged device model	–	±500	V
		Machine model	–	±200	V
T_J	Junction temperature		–	125	°C
T_{SOL}	Soldering temperature(4)		–	220	°C
T_{STG}	Storage temperature		–65	150	°C

Notes:

1. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions beyond those listed under the Recommended Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time adversely affects device reliability.
2. All User I/O and Dual-Purpose pins (DIN/D0, D1–D7, CS_B, RDWR_B, BUSY/DOUT, and INIT_B) draw power from the V_{CCO} power rail of the associated bank. Keeping VIN within 500 mV of the associated V_{CCO} rails or ground rail ensures that the internal diode junctions that exist between each of these pins and the V_{CCO} and GND rails do not turn on. Table 32 specifies the V_{CCO} range used to determine the max limit. Input voltages outside the –0.5V to V_{CCO}+0.5V voltage range are permissible provided that the I_{IK} input clamp diode rating is met and no more than 100 pins exceed the range simultaneously. Prolonged exposure to such current may compromise device reliability. A sustained current of 10 mA will not compromise device reliability. See XAPP459, *Eliminating I/O Coupling Effects when Interfacing Large-Swing Single-Ended Signals to User I/O Pins on Spartan-3 Generation FPGAs* for more details. The VIN limits apply to both the DC and AC components of signals. Simple application solutions are available that show how to handle overshoot/undershoot as well as achieve PCI compliance. Refer to the following application notes: XAPP457, *Powering and Configuring Spartan-3 Generation FPGAs in Compliant PCI Applications* and XAPP659, *Virtex®-II Pro / Virtex-II Pro X 3.3V I/O Design Guidelines*.
3. All Dedicated pins (M0–M2, CCLK, PROG_B, DONE, HSWAP_EN, TCK, TDI, TDO, and TMS) draw power from the V_{CCAUX} rail (2.5V). Meeting the V_{IN} max limit ensures that the internal diode junctions that exist between each of these pins and the V_{CCAUX} rail do not turn on. Table 32 specifies the V_{CCAUX} range used to determine the max limit. When V_{CCAUX} is at its maximum recommended operating level (2.625V), V_{IN} max < 3.125V. As long as the V_{IN} max specification is met, oxide stress is not possible. For information concerning the use of 3.3V signals, see the 3.3V-Tolerant Configuration Interface, page 47. See also XAPP459.
4. For soldering guidelines, see UG112, *Device Packaging and Thermal Characteristics* and XAPP427, *Implementation and Solder Reflow Guidelines for Pb-Free Packages*.

Table 29: **Supply Voltage Thresholds for Power-On Reset**

Symbol	Description	Min	Max	Units
V_{CCINTT}	Threshold for the V_{CCINT} supply	0.4	1.0	V
V_{CCAUXT}	Threshold for the V_{CCAUX} supply	0.8	2.0	V
V_{CCO4T}	Threshold for the V_{CCO} Bank 4 supply	0.4	1.0	V

Notes:

1. V_{CCINT}, V_{CCAUX}, and V_{CCO} supplies may be applied in any order. When applying V_{CCINT} power before V_{CCAUX} power, the FPGA may draw a *surplus* current in addition to the quiescent current levels specified in Table 34. Applying V_{CCAUX} eliminates the surplus current. The FPGA does not use any of the surplus current for the power-on process. For this power sequence, make sure that regulators with foldback features will not shut down inadvertently.
2. To ensure successful power-on, V_{CCINT}, V_{CCO} Bank 4, and V_{CCAUX} supplies must rise through their respective threshold-voltage ranges with no dips at any point.
3. If a brown-out condition occurs where V_{CCAUX} or V_{CCINT} drops below the retention voltage indicated in Table 31, then V_{CCAUX} or V_{CCINT} must drop below the minimum power-on reset voltage in order to clear out the device configuration content.

Table 42: **Setup and Hold Times for the IOB Input Path *(Cont'd)***

Symbol	Description	Conditions	Device	Speed Grade -5 Min	Speed Grade -4 Min	Units
Hold Times						
T_{IOICKP}	Time from the active transition at the IFF's ICLK input to the point where data must be held at the Input pin. No Input Delay is programmed.	LVCMOS25[(3)], IOBDELAY = NONE	XC3S50	-0.55	-0.55	ns
			XC3S200	-0.29	-0.29	ns
			XC3S400	-0.29	-0.29	ns
			XC3S1000	-0.55	-0.55	ns
			XC3S1500	-0.55	-0.55	ns
			XC3S2000	-0.55	-0.55	ns
			XC3S4000	-0.61	-0.61	ns
			XC3S5000	-0.68	-0.68	ns
$T_{IOICKPD}$	Time from the active transition at the IFF's ICLK input to the point where data must be held at the Input pin. The Input Delay is programmed.	LVCMOS25[(3)], IOBDELAY = IFD	XC3S50	-2.74	-2.74	ns
			XC3S200	-3.00	-3.00	ns
			XC3S400	-2.90	-2.90	ns
			XC3S1000	-3.24	-3.24	ns
			XC3S1500	-3.55	-3.55	ns
			XC3S2000	-4.57	-4.57	ns
			XC3S4000	-4.96	-4.96	ns
			XC3S5000	-5.09	-5.09	ns
Set/Reset Pulse Width						
T_{RPW_IOB}	Minimum pulse width to SR control input on IOB		All	0.66	0.76	ns

Notes:

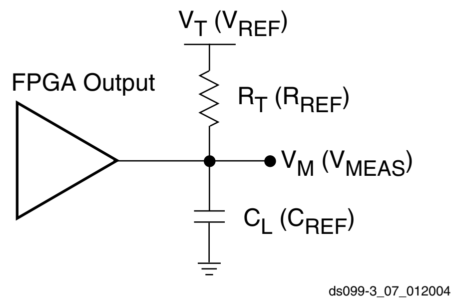
1. The numbers in this table are tested using the methodology presented in Table 48 and are based on the operating conditions set forth in Table 32 and Table 35.
2. This setup time requires adjustment whenever a signal standard other than LVCMOS25 is assigned to the data Input. If this is true, add the appropriate Input adjustment from Table 44.
3. These hold times require adjustment whenever a signal standard other than LVCMOS25 is assigned to the data Input. If this is true, subtract the appropriate Input adjustment from Table 44. When the hold time is negative, it is possible to change the data before the clock's active edge.

Timing Measurement Methodology

When measuring timing parameters at the programmable I/Os, different signal standards call for different test conditions. Table 48 presents the conditions to use for each standard.

The method for measuring Input timing is as follows: A signal that swings between a Low logic level of V_L and a High logic level of V_H is applied to the Input under test. Some standards also require the application of a bias voltage to the V_{REF} pins of a given bank to properly set the input-switching threshold. The measurement point of the Input signal (V_M) is commonly located halfway between V_L and V_H.

The Output test setup is shown in Figure 35. A termination voltage V_T is applied to the termination resistor R_T, the other end of which is connected to the Output. For each standard, R_T and V_T generally take on the standard values recommended for minimizing signal reflections. If the standard does not ordinarily use terminations (e.g., LVCMOS, LVTTL), then R_T is set to 1MΩ to indicate an open connection, and V_T is set to zero. The same measurement point (V_M) that was used at the Input is also used at the Output.



Notes:

1. The names shown in parentheses are used in the IBIS file.

Figure 35: **Output Test Setup**

Table 48: **Test Methods for Timing Measurement at I/Os**

Signal Standard (IOSTANDARD)	Inputs			Outputs		Inputs and Outputs
	V_{REF} (V)	V_L (V)	V_H (V)	R_T (Ω)	V_T (V)	V_M (V)
Single-Ended						
GTL	0.8	V_{REF} – 0.2	V_{REF} + 0.2	25	1.2	V_{REF}
GTL_DCI				50	1.2	
GTLP	1.0	V_{REF} – 0.2	V_{REF} + 0.2	25	1.5	V_{REF}
GTLP_DCI				50	1.5	
HSLVDCI_15	0.9	V_{REF} – 0.5	V_{REF} + 0.5	1M	0	0.75
HSLVDCI_18						0.90
HSLVDCI_25						1.25
HSLVDCI_33						1.65
HSTL_I	0.75	V_{REF} – 0.5	V_{REF} + 0.5	50	0.75	V_{REF}
HSTL_I_DCI						
HSTL_III	0.90	V_{REF} – 0.5	V_{REF} + 0.5	50	1.5	V_{REF}
HSTL_III_DCI						
HSTL_I_18	0.90	V_{REF} – 0.5	V_{REF} + 0.5	50	0.9	V_{REF}
HSTL_I_DCI_18						
HSTL_II_18	0.90	V_{REF} – 0.5	V_{REF} + 0.5	50	0.9	V_{REF}
HSTL_II_DCI_18						

Internal Logic Timing

Table 51: **CLB Timing**

Symbol	Description	Speed Grade -5 Min	Speed Grade -5 Max	Speed Grade -4 Min	Speed Grade -4 Max	Units
Clock-to-Output Times						
T_{CKO}	When reading from the FFX (FFY) Flip-Flop, the time from the active transition at the CLK input to data appearing at the XQ (YQ) output	–	0.63	–	0.72	ns
Setup Times						
T_{AS}	Time from the setup of data at the F or G input to the active transition at the CLK input of the CLB	0.46	–	0.53	–	ns
T_{DICK}	Time from the setup of data at the BX or BY input to the active transition at the CLK input of the CLB	1.27	–	1.57	–	ns
Hold Times						
T_{AH}	Time from the active transition at the CLK input to the point where data is last held at the F or G input	0	–	0	–	ns
T_{CKDI}	Time from the active transition at the CLK input to the point where data is last held at the BX or BY input	0.25	–	0.29	–	ns
Clock Timing						
T_{CH}	CLB CLK signal High pulse width	0.69	∞	0.79	∞	ns
T_{CL}	CLB CLK signal Low pulse width	0.69	∞	0.79	∞	ns
F_{TOG}	Maximum toggle frequency (for export control)	–	725	–	630	MHz
Propagation Times						
T_{ILO}	The time it takes for data to travel from the CLB's F (G) input to the X (Y) output	–	0.53	–	0.61	ns
Set/Reset Pulse Width						
T_{RPW_CLB}	The minimum allowable pulse width, High or Low, to the CLB's SR input	0.76	–	0.87	–	ns

Notes:
1. The numbers in this table are based on the operating conditions set forth in Table 32.
2. The timing shown is for SLICEM.
3. For minimums, use the values reported by the Xilinx timing analyzer.

Mechanical Drawings

Detailed mechanical drawings for each package type are available from the Xilinx website at the specified location in Table 83.

Material Declaration Data Sheets (MDDS) are also available on the Xilinx website for each package.

Table 83: **Xilinx Package Mechanical Drawings**

Package	Web Link (URL)
VQ100 and VQG100	http://www.xilinx.com/support/documentation/package_specs/vq100.pdf
CP132 and CPG132[(1)]	http://www.xilinx.com/support/documentation/package_specs/cp132.pdf
TQ144 and TQG144	http://www.xilinx.com/support/documentation/package_specs/tq144.pdf
PQ208 and PQG208	http://www.xilinx.com/support/documentation/package_specs/pq208.pdf
FT256 and FTG256	http://www.xilinx.com/support/documentation/package_specs/ft256.pdf
FG320 and FGG320	http://www.xilinx.com/support/documentation/package_specs/fg320.pdf
FG456 and FGG456	http://www.xilinx.com/support/documentation/package_specs/fg456.pdf
FG676 and FGG676	http://www.xilinx.com/support/documentation/package_specs/fg676.pdf
FG900 and FGG900	http://www.xilinx.com/support/documentation/package_specs/fg900.pdf
FG1156 and FGG1156[(1)]	http://www.xilinx.com/support/documentation/package_specs/fg1156.pdf

Notes:
1. The CP132, CPG132, FG1156, and FGG1156 packages are discontinued. See http://www.xilinx.com/support/documentation/spartan-3_customer_notices.htm.

Power, Ground, and I/O by Package

Each package has three separate voltage supply inputs—VCCINT, VCCAUX, and VCCO—and a common ground return, GND. The numbers of pins dedicated to these functions varies by package, as shown in Table 84.

Table 84: **Power and Ground Supply Pins by Package**

Package	VCCINT	VCCAUX	VCCO	GND
VQ100	4	4	8	10
CP132[(1)]	4	4	12	12
TQ144	4	4	12	16
PQ208	4	8	12	28
FT256	8	8	24	32
FG320	12	8	28	40
FG456	12	8	40	52
FG676	20	16	64	76
FG900	32	24	80	120
FG1156[(1)]	40	32	104	184

Notes:
1. The CP132, CPG132, FG1156, and FGG1156 packages are discontinued. See http://www.xilinx.com/support/documentation/spartan-3_customer_notices.htm.

A majority of package pins are user-defined I/O pins. However, the numbers and characteristics of these I/O depends on the device type and the package in which it is available, as shown in Table 85. The table shows the maximum number of single-ended I/O pins available, assuming that all I/O-, DUAL-, DCI-, VREF-, and GCLK-type pins are used as general-purpose I/O. Likewise, the table shows the maximum number of differential pin-pairs available on the package. Finally, the table shows how the total maximum user I/Os are distributed by pin type, including the number of unconnected—i.e., N.C.—pins on the device.

Table 87: **VQ100 Package Pinout *(Cont'd)***

Bank	XC3S50 XC3S200 Pin Name	VQ100 Pin Number	Type
VCCAUX	TDO	P76	JTAG
VCCAUX	TMS	P78	JTAG

User I/Os by Bank

Table 88 indicates how the available user-I/O pins are distributed between the eight I/O banks on the VQ100 package.

Table 88: **User I/Os Per Bank in VQ100 Package**

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	DUAL	DCI	VREF	GCLK
Top	0	6	1	0	2	1	2
	1	7	2	0	2	1	2
Right	2	8	5	0	2	1	0
	3	8	5	0	2	1	0
Bottom	4	10	0	6	2	0	2
	5	8	0	6	0	0	2
Left	6	8	4	0	2	2	0
	7	8	5	0	2	1	0

User I/Os by Bank

Table 92 indicates how the available user-I/O pins are distributed between the eight I/O banks on the TQ144 package.

Table 92: **User I/Os Per Bank in TQ144 Package**

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	DUAL	DCI	VREF	GCLK
Top	0	10	5	0	2	1	2
	1	9	4	0	2	1	2
Right	2	14	10	0	2	2	0
	3	15	11	0	2	2	0
Bottom	4	11	0	6	2	1	2
	5	9	0	6	0	1	2
Left	6	14	10	0	2	2	0
	7	15	11	0	2	2	0

Right Half of Package (Top View)

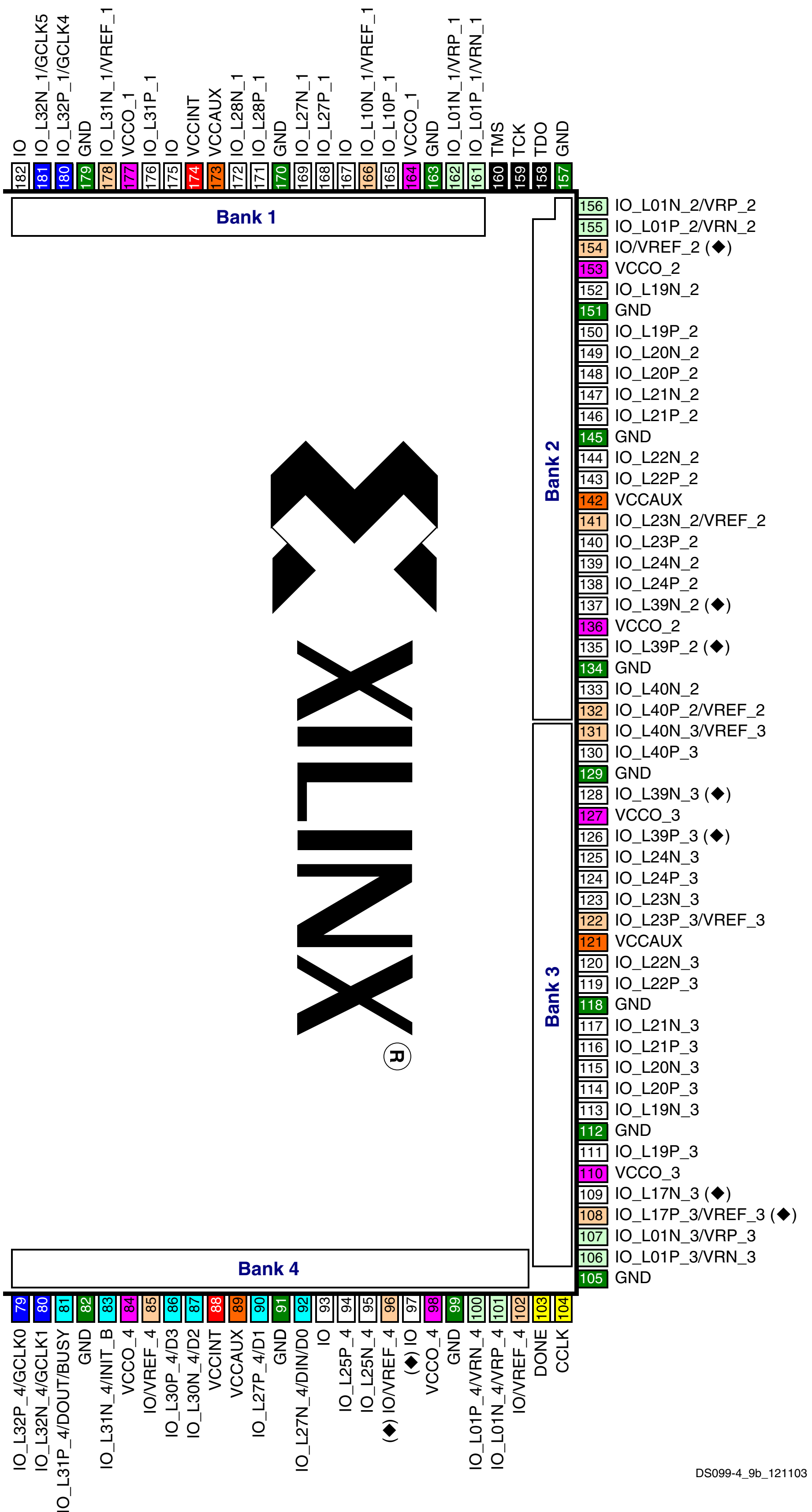


Figure 48: PQ208 Package Footprint (Top View) Continued

Table 100: **FG456 Package Pinout *(Cont'd)***

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
4	IO_L30N_4/D2	IO_L30N_4/D2	U12	DUAL
4	IO_L30P_4/D3	IO_L30P_4/D3	V12	DUAL
4	IO_L31N_4/INIT_B	IO_L31N_4/INIT_B	W12	DUAL
4	IO_L31P_4/DOUT/BUSY	IO_L31P_4/DOUT/BUSY	Y12	DUAL
4	IO_L32N_4/GCLK1	IO_L32N_4/GCLK1	AA12	GCLK
4	IO_L32P_4/GCLK0	IO_L32P_4/GCLK0	AB12	GCLK
4	VCCO_4	VCCO_4	T12	VCCO
4	VCCO_4	VCCO_4	T13	VCCO
4	VCCO_4	VCCO_4	T14	VCCO
4	VCCO_4	VCCO_4	U15	VCCO
4	VCCO_4	VCCO_4	Y15	VCCO
5	IO	IO	U7	I/O
5	N.C. (◆)	IO	U9	I/O
5	IO	IO	U10	I/O
5	IO	IO	U11	I/O
5	IO	IO	V7	I/O
5	IO	IO	V10	I/O
5	IO/VREF_5	IO/VREF_5	AB11	VREF
5	IO/VREF_5	IO/VREF_5	U6	VREF
5	IO_L01N_5/RDWR_B	IO_L01N_5/RDWR_B	Y4	DUAL
5	IO_L01P_5/CS_B	IO_L01P_5/CS_B	AA3	DUAL
5	IO_L06N_5	IO_L06N_5	AB4	I/O
5	IO_L06P_5	IO_L06P_5	AA4	I/O
5	IO_L09N_5	IO_L09N_5	Y5	I/O
5	IO_L09P_5	IO_L09P_5	W5	I/O
5	IO_L10N_5/VRP_5	IO_L10N_5/VRP_5	AB5	DCI
5	IO_L10P_5/VRN_5	IO_L10P_5/VRN_5	AA5	DCI
5	IO_L15N_5	IO_L15N_5	W6	I/O
5	IO_L15P_5	IO_L15P_5	V6	I/O
5	IO_L16N_5	IO_L16N_5	AA6	I/O
5	IO_L16P_5	IO_L16P_5	Y6	I/O
5	N.C. (◆)	IO_L19N_5	Y7	I/O
5	N.C. (◆)	IO_L19P_5/ VREF_5	W7	VREF
5	N.C. (◆)	IO_L22N_5	AB7	I/O
5	N.C. (◆)	IO_L22P_5	AA7	I/O
5	IO_L24N_5	IO_L24N_5	W8	I/O
5	IO_L24P_5	IO_L24P_5	V8	I/O
5	IO_L25N_5	IO_L25N_5	AB8	I/O
5	IO_L25P_5	IO_L25P_5	AA8	I/O

Right Half of FG900 Package (Top View)

Bank 1

	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30
A	I/O	GND	I/O L39N_1 ◆	I/O L26N_1	I/O L21N_1	GND	I/O L15N_1	I/O L11N_1	I/O L07N_1	GND	I/O L03N_1	I/O L01N_1 VRP_1	TMS	GND	GND
B	I/O L32N_1 GCLK5	I/O L28N_1	I/O L39P_1 ◆	I/O L26P_1	I/O L21P_1	I/O L17N_1 VREF_1	I/O L15P_1	I/O L11P_1	I/O L07P_1	I/O L04N_1	I/O L03P_1	I/O L01P_1 VRN_1	TCK	GND	GND
C	I/O L32P_1 GCLK4	I/O L28P_1	VCCO_1	I/O L25N_1	I/O L20N_1	I/O L17P_1	VCCO_1	I/O L10N_1 VREF_1	I/O L06N_1 VREF_1	I/O L04P_1	VCCO_1	I/O L02P_1	TDO	I/O L01N_2 VRP_2	I/O L01P_2 VRN_2
D	I/O L31N_1 VREF_1	VCCAUX	I/O L38N_1 ◆	I/O L25P_1	I/O L20P_1	VCCAUX	I/O L14N_1	I/O L10P_1	I/O L06P_1	VCCAUX	I/O L02N_1	I/O L02N_2	I/O L02P_2	I/O L03N_2 VREF_2	I/O L03P_2
E	I/O L31P_1	GND	I/O L38P_1 ◆	I/O L24N_1	I/O L19N_1	GND	I/O L14P_1	I/O L13P_1	VCCO_1	I/O	GND	I/O L41N_2 ◆	VCCO_2	I/O L04N_2	I/O L04P_2
F	I/O	I/O L27N_1	I/O	I/O L24P_1	I/O L19P_1	I/O L16N_1	I/O L13N_1	I/O L09N_1	I/O L05N_1	I/O L05P_1	I/O L41P_2 ◆	VCCAUX	I/O L05N_2	I/O L05P_2	GND
G	I/O L30N_1	I/O L27P_1	VCCO_1	I/O L23N_1	I/O L18N_1	I/O L16P_1	VCCO_1	I/O L09P_1	I/O L08P_1	I/O L08N_2	VCCO_2	I/O L06N_2	I/O L06P_2	I/O L07N_2	I/O L07P_2
H	I/O L30P_1	GND	I/O L37N_1 ◆	I/O L23P_1	I/O L18P_1	GND	I/O L12N_1	I/O L08N_1	I/O L08P_2	I/O L09N_2 VREF_2	I/O L09P_2	I/O L10N_2	I/O L10P_2	I/O L12N_2	I/O L12P_2
J	I/O L29N_1	IO VREF_1	I/O L37P_1 ◆	I/O L22N_1	VCCO_1	I/O	I/O L12P_1	I/O L15N_2	VCCO_2	I/O	I/O L13N_2	I/O L13P_2 VREF_2	VCCO_2	I/O L14N_2	I/O L14P_2
K	I/O L29P_1	I/O L40N_1 ◆	I/O L40P_1 ◆	I/O L22P_1	I/O	I/O L46N_2 ◆	I/O L15P_2	GND	I/O L16N_2	I/O L16P_2	GND	VCCAUX	I/O L45N_2 ◆	I/O L45P_2 ◆	GND
L	VCCINT	VCCO_1	VCCO_1	VCCO_1	VCCINT	I/O L46P_2 ◆	VCCO_2	I/O L47N_2 ◆	I/O L47P_2 ◆	I/O L19N_2	I/O L19P_2	I/O L20N_2	I/O L20P_2	I/O L21N_2	I/O L21P_2
M	GND	VCCINT	VCCINT	VCCINT	VCCO_2	I/O L26N_2	I/O L22N_2	I/O L22P_2	I/O L23N_2 VREF_2	I/O L23P_2	I/O L28N_2	I/O L24N_2	I/O L24P_2	I/O L50N_2 ◆	I/O L50P_2 ◆
N	GND	GND	GND	VCCINT	VCCO_2	I/O L26P_2	I/O L27N_2	I/O L27P_2	VCCO_2	I/O L28P_2	I/O L29N_2	I/O L29P_2	VCCO_2	I/O L31N_2	I/O L31P_2
P	GND	GND	GND	VCCINT	VCCO_2	I/O L32N_2	I/O L32P_2	GND	I/O L33N_2	I/O L33P_2	GND	VCCAUX	I/O L34N_2 VREF_2	I/O L34P_2	GND
R	GND	GND	GND	GND	VCCINT	I/O L35N_2	I/O L35P_2	I/O L37N_2	I/O L37P_2	I/O L38N_2	I/O L38P_2	I/O L39N_2	I/O L39P_2	I/O L40N_2	I/O L40P_2 VREF_2
T	GND	GND	GND	GND	VCCINT	I/O L35P_3	I/O L35N_3	I/O L37P_3	I/O L37N_3	I/O L38P_3	I/O L38N_3	I/O L39P_3	I/O L39N_3	I/O L40P_3	I/O L40N_3 VREF_3
U	GND	GND	GND	VCCINT	VCCO_3	I/O L32P_3	I/O L32N_3	GND	I/O L33P_3	I/O L33N_3	GND	VCCAUX	I/O L34P_3 VREF_3	I/O L34N_3	GND
V	GND	GND	GND	VCCINT	VCCO_3	I/O L27N_3	I/O L28P_3	I/O L28N_3	VCCO_3	I/O L29N_3	I/O L50P_3 ◆	I/O L50N_3 ◆	VCCO_3	I/O L31P_3	I/O L31N_3
W	GND	VCCINT	VCCINT	VCCINT	VCCO_3	I/O L27P_3	I/O L46P_3 ◆	I/O L46N_3 ◆	I/O L47P_3 ◆	I/O L47N_3 ◆	I/O L29P_3	I/O L48P_3 ◆	I/O L48N_3 ◆	I/O L26P_3	I/O L26N_3
Y	VCCINT	VCCO_4	VCCO_4	VCCO_4	VCCINT	I/O L20N_3	VCCO_3	I/O L21P_3	I/O L21N_3	I/O L22P_3	I/O L22N_3	I/O L23P_3 VREF_3	I/O L23N_3	I/O L24P_3	I/O L24N_3
AA	I/O	I/O L26N_4	I/O	I/O L18N_4	I/O L13P_4	I/O L20P_3	I/O L16N_3	GND	I/O L17P_3 VREF_3	I/O L17N_3	GND	VCCAUX	I/O L19P_3	I/O L19N_3	GND
AB	I/O L29N_4	I/O L26P_4 VREF_4	I/O L23N_4	I/O L18P_4	VCCO_4	I/O L13N_4	I/O L08N_4	I/O L16P_3	VCCO_3	I/O	I/O L14P_3	I/O L14N_3	VCCO_3	I/O L15P_3	I/O L15N_3
AC	I/O L29P_4	GND	I/O L23P_4	I/O L19N_4	I/O L14N_4	GND	I/O L08P_4	I/O L04P_4	I/O L09N_3	I/O L10P_3	I/O L10N_3	I/O L11P_3	I/O L11N_3	I/O L13P_3	I/O L13N_3 VREF_3
AD	I/O L30N_4 D2	I/O L27N_4 DIN D0	VCCO_4	I/O L19P_4	I/O L14P_4	I/O L11N_4	VCCO_4	I/O	I/O L04N_4	I/O L09P_3 VREF_3	VCCO_3	I/O L07P_3	I/O L07N_3	I/O L08P_3	I/O L08N_3
AE	I/O L30P_4 D3	I/O L27P_4 D1	I/O L24N_4	I/O L20N_4	I/O L15N_4	I/O L11P_4	I/O	I/O L05N_4	I/O L34P_4 ◆	I/O L34N_4 ◆	I/O L05N_3	VCCAUX	I/O L06P_3	I/O L06N_3	GND
AF	I/O VREF_4	GND	I/O L24P_4	I/O L20P_4	I/O L15P_4	GND	I/O L09N_4	I/O L05P_4	VCCO_4	I/O L03P_4	GND	I/O L05P_3	VCCO_3	I/O L04P_3	I/O L04N_3
AG	I/O L31N_4 INIT_B	VCCAUX	I/O	I/O L21N_4	I/O L16N_4	VCCAUX	I/O L09P_4	I/O L06N_4 VREF_4	I/O L35N_4 ◆	VCCAUX	I/O L03N_4	I/O L02P_3	I/O L02N_3 VREF_3	I/O L03P_3	I/O L03N_3
AH	I/O L31P_4 DOUT BUSY	I/O L28N_4	VCCO_4	I/O L21P_4	I/O L16P_4	I/O L12N_4	VCCO_4	I/O L06P_4	I/O L35P_4 ◆	I/O L33N_4 ◆	VCCO_4	I/O	CCLK	I/O L01P_3 VRN_3	I/O L01N_3 VRP_3
AJ	I/O L32N_4 GCLK1	I/O L28P_4	I/O L25N_4	I/O L22N_4 VREF_4	I/O L17N_4	I/O L12P_4	I/O L10N_4	I/O L07N_4	I/O L38N_4 ◆	I/O L33P_4 ◆	I/O L02N_4	I/O L01N_4 VRP_4	DONE	GND	GND
AK	I/O L32P_4 GCLK0	GND	I/O L25P_4	I/O L22P_4	I/O L17P_4	GND	I/O L10P_4	I/O L07P_4	I/O L38P_4 ◆	GND	I/O L02P_4	I/O L01P_4 VRN_4	IO VREF_4	GND	GND

Bank 2

Bank 3

Bank 4

DS099-4_13b_121103

Figure 56: FG900 Package Footprint (Top View) Continued

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
0	VCCO_0	VCCO_0	F13	VCCO
0	VCCO_0	VCCO_0	G8	VCCO
0	VCCO_0	VCCO_0	H11	VCCO
0	VCCO_0	VCCO_0	H15	VCCO
0	VCCO_0	VCCO_0	M13	VCCO
0	VCCO_0	VCCO_0	M14	VCCO
0	VCCO_0	VCCO_0	M15	VCCO
0	VCCO_0	VCCO_0	M16	VCCO
1	IO	IO	B26	I/O
1	IO	IO	A18	I/O
1	IO	IO	C23	I/O
1	IO	IO	E21	I/O
1	IO	IO	E25	I/O
1	IO	IO	F18	I/O
1	IO	IO	F27	I/O
1	IO	IO	F29	I/O
1	IO	IO	H23	I/O
1	IO	IO	H26	I/O
1	N.C. (◆)	IO	J26	I/O
1	IO	IO	K19	I/O
1	IO	IO	L19	I/O
1	IO	IO	L20	I/O
1	IO	IO	L21	I/O
1	N.C. (◆)	IO	L23	I/O
1	IO	IO	L24	I/O
1	IO/VREF_1	IO/VREF_1	D30	VREF
1	IO/VREF_1	IO/VREF_1	K21	VREF
1	IO/VREF_1	IO/VREF_1	L18	VREF
1	IO_L01N_1/VRP_1	IO_L01N_1/VRP_1	A32	DCI
1	IO_L01P_1/VRN_1	IO_L01P_1/VRN_1	B32	DCI
1	IO_L02N_1	IO_L02N_1	A31	I/O
1	IO_L02P_1	IO_L02P_1	B31	I/O
1	IO_L03N_1	IO_L03N_1	B30	I/O
1	IO_L03P_1	IO_L03P_1	C30	I/O
1	IO_L04N_1	IO_L04N_1	C29	I/O
1	IO_L04P_1	IO_L04P_1	D29	I/O
1	IO_L05N_1	IO_L05N_1	A29	I/O
1	IO_L05P_1	IO_L05P_1	B29	I/O
1	IO_L06N_1/VREF_1	IO_L06N_1/VREF_1	E28	VREF
1	IO_L06P_1	IO_L06P_1	F28	I/O

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
1	IO_L07N_1	IO_L07N_1	D27	I/O
1	IO_L07P_1	IO_L07P_1	E27	I/O
1	IO_L08N_1	IO_L08N_1	A27	I/O
1	IO_L08P_1	IO_L08P_1	B27	I/O
1	IO_L09N_1	IO_L09N_1	F26	I/O
1	IO_L09P_1	IO_L09P_1	G26	I/O
1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	C26	VREF
1	IO_L10P_1	IO_L10P_1	D26	I/O
1	IO_L11N_1	IO_L11N_1	H25	I/O
1	IO_L11P_1	IO_L11P_1	J25	I/O
1	IO_L12N_1	IO_L12N_1	F25	I/O
1	IO_L12P_1	IO_L12P_1	G25	I/O
1	IO_L13N_1	IO_L13N_1	C25	I/O
1	IO_L13P_1	IO_L13P_1	D25	I/O
1	IO_L14N_1	IO_L14N_1	A25	I/O
1	IO_L14P_1	IO_L14P_1	B25	I/O
1	IO_L15N_1	IO_L15N_1	A24	I/O
1	IO_L15P_1	IO_L15P_1	B24	I/O
1	IO_L16N_1	IO_L16N_1	J23	I/O
1	IO_L16P_1	IO_L16P_1	K23	I/O
1	IO_L17N_1/VREF_1	IO_L17N_1/VREF_1	F23	VREF
1	IO_L17P_1	IO_L17P_1	G23	I/O
1	IO_L18N_1	IO_L18N_1	D23	I/O
1	IO_L18P_1	IO_L18P_1	E23	I/O
1	IO_L19N_1	IO_L19N_1	A23	I/O
1	IO_L19P_1	IO_L19P_1	B23	I/O
1	IO_L20N_1	IO_L20N_1	K22	I/O
1	IO_L20P_1	IO_L20P_1	L22	I/O
1	IO_L21N_1	IO_L21N_1	G22	I/O
1	IO_L21P_1	IO_L21P_1	H22	I/O
1	IO_L22N_1	IO_L22N_1	C22	I/O
1	IO_L22P_1	IO_L22P_1	D22	I/O
1	IO_L23N_1	IO_L23N_1	H21	I/O
1	IO_L23P_1	IO_L23P_1	J21	I/O
1	IO_L24N_1	IO_L24N_1	F21	I/O
1	IO_L24P_1	IO_L24P_1	G21	I/O
1	IO_L25N_1	IO_L25N_1	C21	I/O
1	IO_L25P_1	IO_L25P_1	D21	I/O
1	IO_L26N_1	IO_L26N_1	A21	I/O
1	IO_L26P_1	IO_L26P_1	B21	I/O

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
3	IO_L03P_3	IO_L03P_3	AK32	I/O
3	IO_L04N_3	IO_L04N_3	AJ32	I/O
3	IO_L04P_3	IO_L04P_3	AJ31	I/O
3	IO_L05N_3	IO_L05N_3	AJ34	I/O
3	IO_L05P_3	IO_L05P_3	AJ33	I/O
3	IO_L06N_3	IO_L06N_3	AH30	I/O
3	IO_L06P_3	IO_L06P_3	AH29	I/O
3	IO_L07N_3	IO_L07N_3	AG30	I/O
3	IO_L07P_3	IO_L07P_3	AG29	I/O
3	IO_L08N_3	IO_L08N_3	AG34	I/O
3	IO_L08P_3	IO_L08P_3	AG33	I/O
3	IO_L09N_3	IO_L09N_3	AF29	I/O
3	IO_L09P_3/VREF_3	IO_L09P_3/VREF_3	AF28	VREF
3	IO_L10N_3	IO_L10N_3	AF31	I/O
3	IO_L10P_3	IO_L10P_3	AG31	I/O
3	IO_L11N_3	IO_L11N_3	AF33	I/O
3	IO_L11P_3	IO_L11P_3	AF32	I/O
3	IO_L12N_3	IO_L12N_3	AE26	I/O
3	IO_L12P_3	IO_L12P_3	AF27	I/O
3	IO_L13N_3/VREF_3	IO_L13N_3/VREF_3	AE28	VREF
3	IO_L13P_3	IO_L13P_3	AE27	I/O
3	IO_L14N_3	IO_L14N_3	AE30	I/O
3	IO_L14P_3	IO_L14P_3	AE29	I/O
3	IO_L15N_3	IO_L15N_3	AE32	I/O
3	IO_L15P_3	IO_L15P_3	AE31	I/O
3	IO_L16N_3	IO_L16N_3	AE34	I/O
3	IO_L16P_3	IO_L16P_3	AE33	I/O
3	IO_L17N_3	IO_L17N_3	AD26	I/O
3	IO_L17P_3/VREF_3	IO_L17P_3/VREF_3	AD25	VREF
3	IO_L19N_3	IO_L19N_3	AD34	I/O
3	IO_L19P_3	IO_L19P_3	AD33	I/O
3	IO_L20N_3	IO_L20N_3	AC25	I/O
3	IO_L20P_3	IO_L20P_3	AC24	I/O
3	IO_L21N_3	IO_L21N_3	AC28	I/O
3	IO_L21P_3	IO_L21P_3	AC27	I/O
3	IO_L22N_3	IO_L22N_3	AC30	I/O
3	IO_L22P_3	IO_L22P_3	AC29	I/O
3	IO_L23N_3	IO_L23N_3	AC32	I/O
3	IO_L23P_3/VREF_3	IO_L23P_3/VREF_3	AC31	VREF
3	IO_L24N_3	IO_L24N_3	AB25	I/O

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
7	IO_L22P_7	IO_L22P_7	M6	I/O
7	IO_L23N_7	IO_L23N_7	M3	I/O
7	IO_L23P_7	IO_L23P_7	M4	I/O
7	IO_L24N_7	IO_L24N_7	N10	I/O
7	IO_L24P_7	IO_L24P_7	M9	I/O
7	IO_L25N_7	IO_L25N_7	N3	I/O
7	IO_L25P_7	IO_L25P_7	N4	I/O
7	IO_L26N_7	IO_L26N_7	P11	I/O
7	IO_L26P_7	IO_L26P_7	N11	I/O
7	IO_L27N_7	IO_L27N_7	P7	I/O
7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	P8	VREF
7	IO_L28N_7	IO_L28N_7	P5	I/O
7	IO_L28P_7	IO_L28P_7	P6	I/O
7	IO_L29N_7	IO_L29N_7	P3	I/O
7	IO_L29P_7	IO_L29P_7	P4	I/O
7	IO_L30N_7	IO_L30N_7	R6	I/O
7	IO_L30P_7	IO_L30P_7	R7	I/O
7	IO_L31N_7	IO_L31N_7	R3	I/O
7	IO_L31P_7	IO_L31P_7	R4	I/O
7	IO_L32N_7	IO_L32N_7	R1	I/O
7	IO_L32P_7	IO_L32P_7	R2	I/O
7	IO_L33N_7	IO_L33N_7	T10	I/O
7	IO_L33P_7	IO_L33P_7	R9	I/O
7	IO_L34N_7	IO_L34N_7	T6	I/O
7	IO_L34P_7	IO_L34P_7	T7	I/O
7	IO_L35N_7	IO_L35N_7	T2	I/O
7	IO_L35P_7	IO_L35P_7	T3	I/O
7	IO_L37N_7	IO_L37N_7	U7	I/O
7	IO_L37P_7/VREF_7	IO_L37P_7/VREF_7	U8	VREF
7	IO_L38N_7	IO_L38N_7	U5	I/O
7	IO_L38P_7	IO_L38P_7	U6	I/O
7	IO_L39N_7	IO_L39N_7	U3	I/O
7	IO_L39P_7	IO_L39P_7	U4	I/O
7	IO_L40N_7/VREF_7	IO_L40N_7/VREF_7	U1	VREF
7	IO_L40P_7	IO_L40P_7	U2	I/O
7	N.C. (◆)	IO_L41N_7	G3	I/O
7	N.C. (◆)	IO_L41P_7	G4	I/O
7	N.C. (◆)	IO_L44N_7	L6	I/O
7	N.C. (◆)	IO_L44P_7	L7	I/O
7	IO_L45N_7	IO_L45N_7	M1	I/O

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
N/A	GND	GND	AA18	GND
N/A	GND	GND	AA19	GND
N/A	GND	GND	AA20	GND
N/A	GND	GND	AA21	GND
N/A	GND	GND	AB1	GND
N/A	GND	GND	AB17	GND
N/A	GND	GND	AB18	GND
N/A	GND	GND	AB26	GND
N/A	GND	GND	AB30	GND
N/A	GND	GND	AB34	GND
N/A	GND	GND	AB5	GND
N/A	GND	GND	AB9	GND
N/A	GND	GND	AD3	GND
N/A	GND	GND	AD32	GND
N/A	GND	GND	AE10	GND
N/A	GND	GND	AE25	GND
N/A	GND	GND	AF1	GND
N/A	GND	GND	AF13	GND
N/A	GND	GND	AF16	GND
N/A	GND	GND	AF19	GND
N/A	GND	GND	AF22	GND
N/A	GND	GND	AF30	GND
N/A	GND	GND	AF34	GND
N/A	GND	GND	AF5	GND
N/A	GND	GND	AH28	GND
N/A	GND	GND	AH7	GND
N/A	GND	GND	AK1	GND
N/A	GND	GND	AK13	GND
N/A	GND	GND	AK16	GND
N/A	GND	GND	AK19	GND
N/A	GND	GND	AK22	GND
N/A	GND	GND	AK26	GND
N/A	GND	GND	AK30	GND
N/A	GND	GND	AK34	GND
N/A	GND	GND	AK5	GND
N/A	GND	GND	AK9	GND
N/A	GND	GND	AM11	GND
N/A	GND	GND	AM24	GND
N/A	GND	GND	AM3	GND
N/A	GND	GND	AM32	GND